

Equipment for Environmental and Reliability Testing

Centrifuge System Drop Tester Electro-Dynamic Shaker HALT (HASS) Chambers Mechanical Shock System Vacuum Chamber Over-Pressure Chamber Rain and Spray Tester Apparatus Salt Fog Chamber Settling Dust Chamber Temperature-Humidity Chambers Thermal Shock Chamber Tumble Tester Walk-in Chamber Data Acquisition System Instron Mechanical Test System Fatigue Life Testers Dynamic & Thermal Mechanical Analyzer Adhesive Pull & Peel System

Equipment for Failure Analysis, Reliability Eng, and Mechanical & Material Characterization

Instron Universal Mechanical Test Machine Dynamic Mechanical Analyzer Thermo Mechanical Analyzer Scanning Electron Microscope X-Ray: 2D and 3D Capabilities Cross-Sectioning Capabilities Dye and Pry Capabilities Optical Microscope with Stitching Capability







Application

Simulates constant acceleration. Direction of Applied Force: Up, Down, Right, Left , Forward and Aft ($\pm X$, $\pm Y \& \pm Z$).

Centrifuge System Spec.		
Model:	CENT-1	
Manufacturer:	Cascade Engineering Services, Inc.	
Maximum Acceleration:	20 g	
Maximum Test Load:	200 lbs	
Work Space Dimensions:	24" x 24"	
Radius (Platform centre to		
rotation centre):	0.95m	

Centrifuge Base Table Hole Pattern (Modifiable)

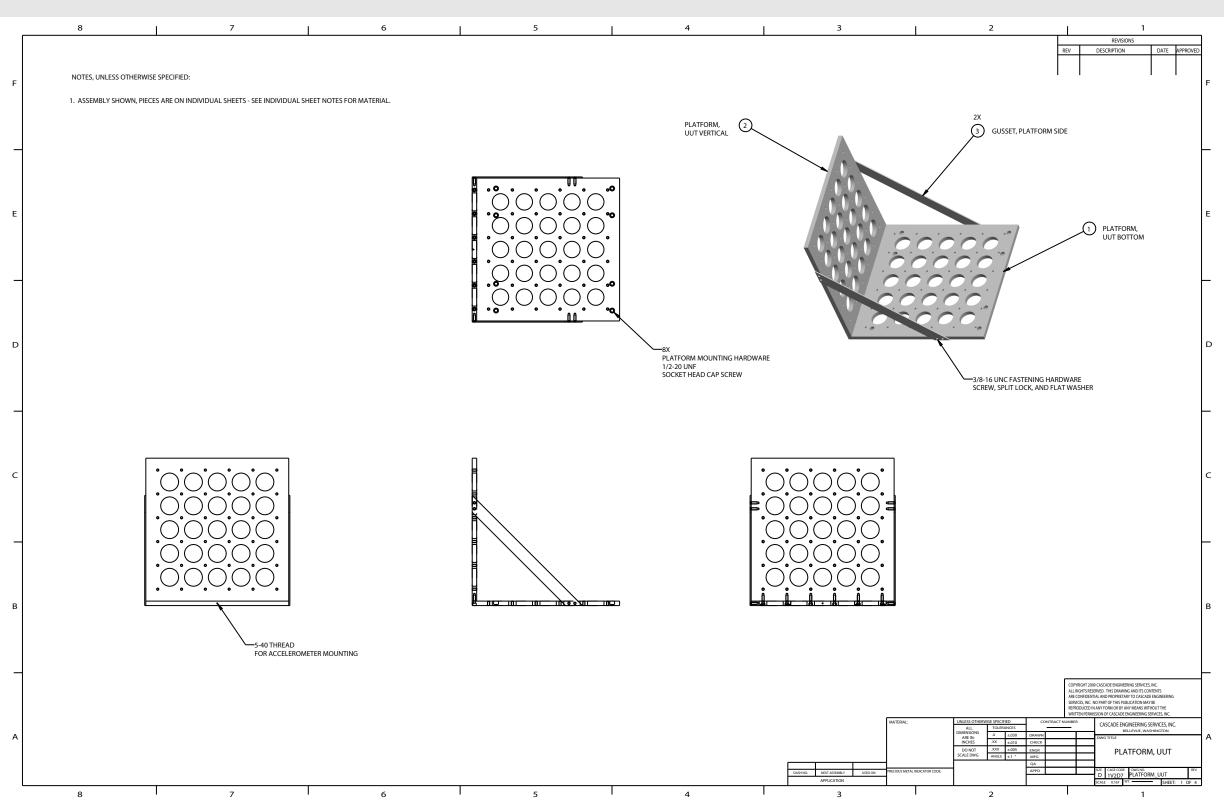
Drawing 01

Drawing 02

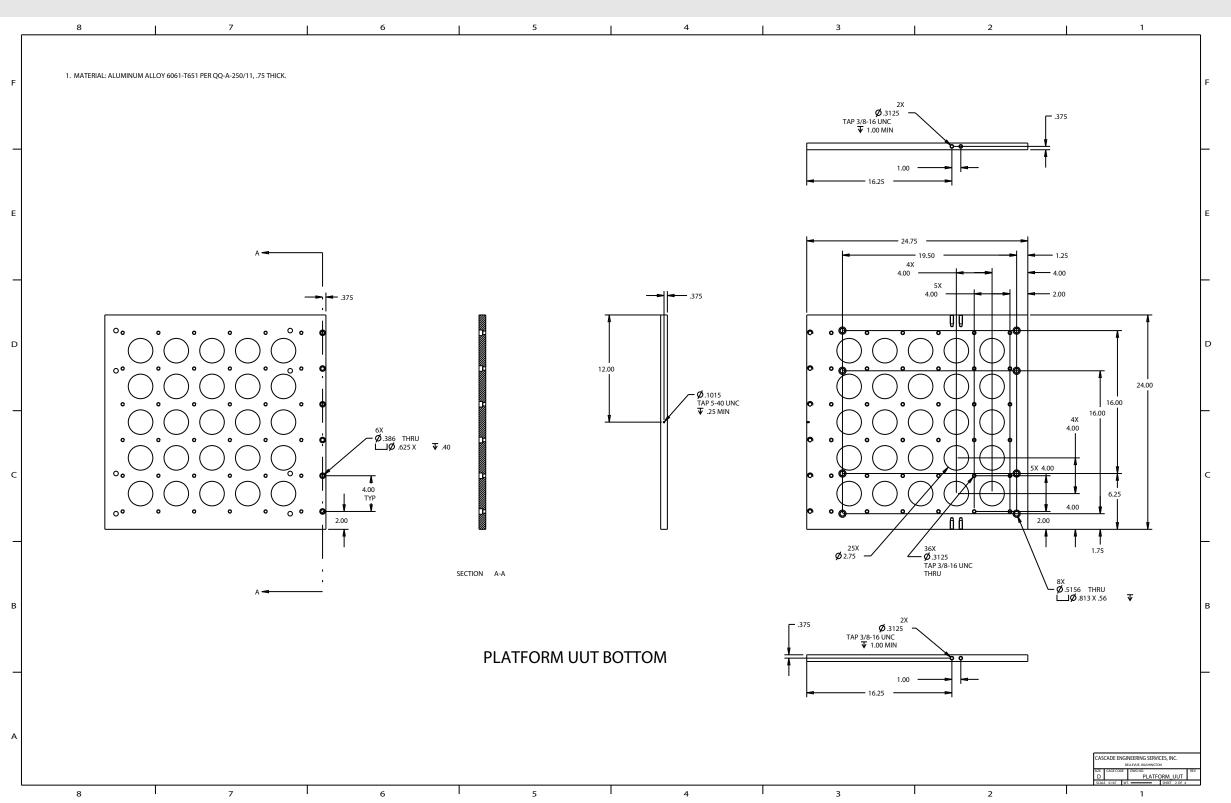
Drawing 03

Drawing 04

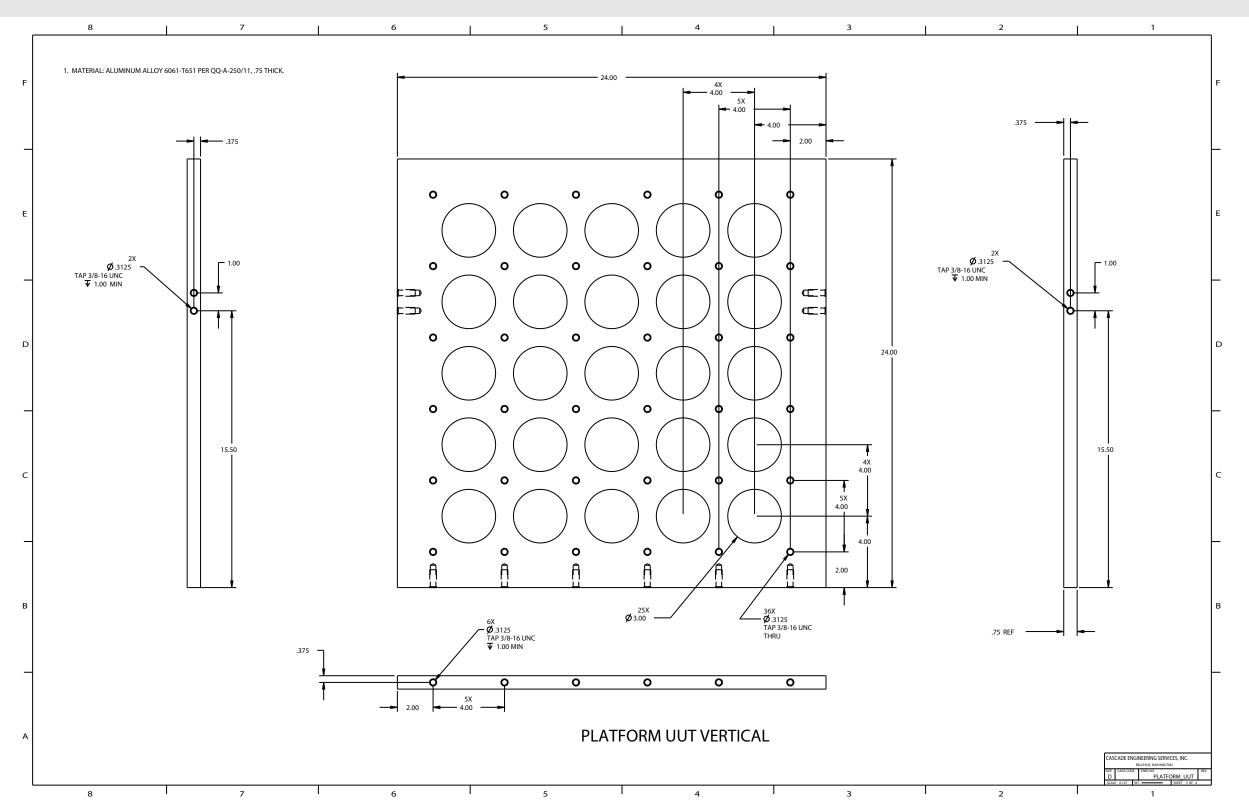




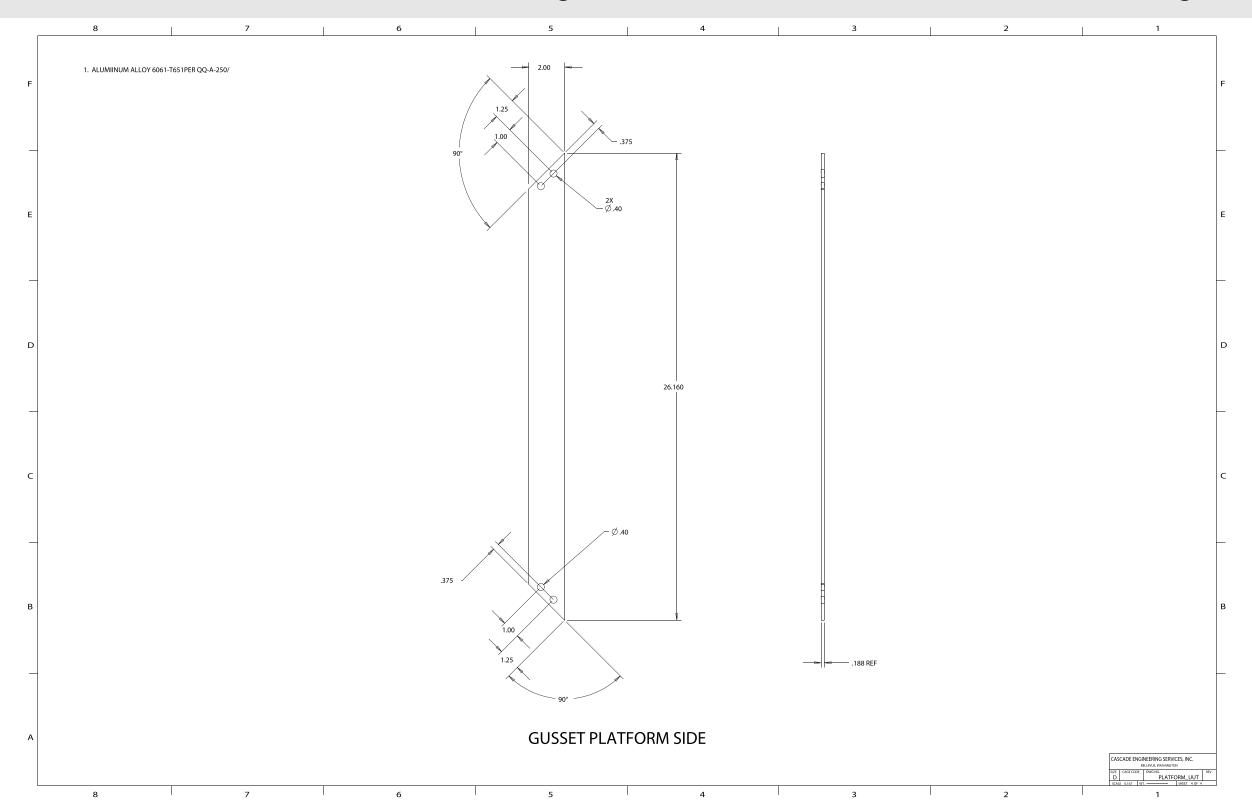














Drop Tester



Simulates accidental drops.		
Centrifuge System Spec.		
	Model:	AD-160A
	Manufacturer:	L.A.B Equipment, Inc.
	Drop Height:	15" to 72"
	Maximum Package Size:	32″
	Maximum Payload Capacity:	160 lbs
	Accessories:	Corner / Edge Drop Holders
	Impact Surface:	30" x 32" steel



Vibration Capability

✓ Sine Sweep & Sine Dwell

 $\sqrt{\text{Sine-on-Random}}$

√ Random-on-Random

√ Random

 \sqrt{SRS}

Electro-Dynamic Shaker



 $\sqrt{}$

√ Trapezoid $\sqrt{\text{Sine Burst}}$

 $\sqrt{}$ Double Sine

√ Initial Sawtooth

Terminal Sawtooth

A single axis Shaker which accelerates the product in 1 direction (X,Y or Z orientation) for component and system level testing. Simulates

Application

loose cargo transportation and truck / trailer transportation.

	E.D. Shaker Spec. (Bare Table)		
	Model:	V3544	
	Manufacturer:	Data Physics	
	Controller:	Data Physics, Signal Star	
	Capacity Force:	8000 lbs	
2	Frequency Range:	2 to 2500 Hz	
	Maximum Velocity:	1.8 m / s	
	Maximum Displacement:	51 mm (2 in)	
11 starter	Bare Table Random:	15 to 20 g rms	
All and the second	Bare Table Sine:	10 to 20 g peak	
	Bare Table Shock:	Up to 70 g peak	
	Accelerometer DAQ:	6 Channels	
Shock Capability	Shaker Table Hole Patterns & Drawing Files		
 ✓ Half Sine ✓ Rectangle ✓ Symmetrical Triangle ✓ Non-Symmetrical Triangle 	<u>Table Hole Pattern (X & Y Axis Orienta</u>	<u>tion)</u>	
v Non Symmetrical mangle			

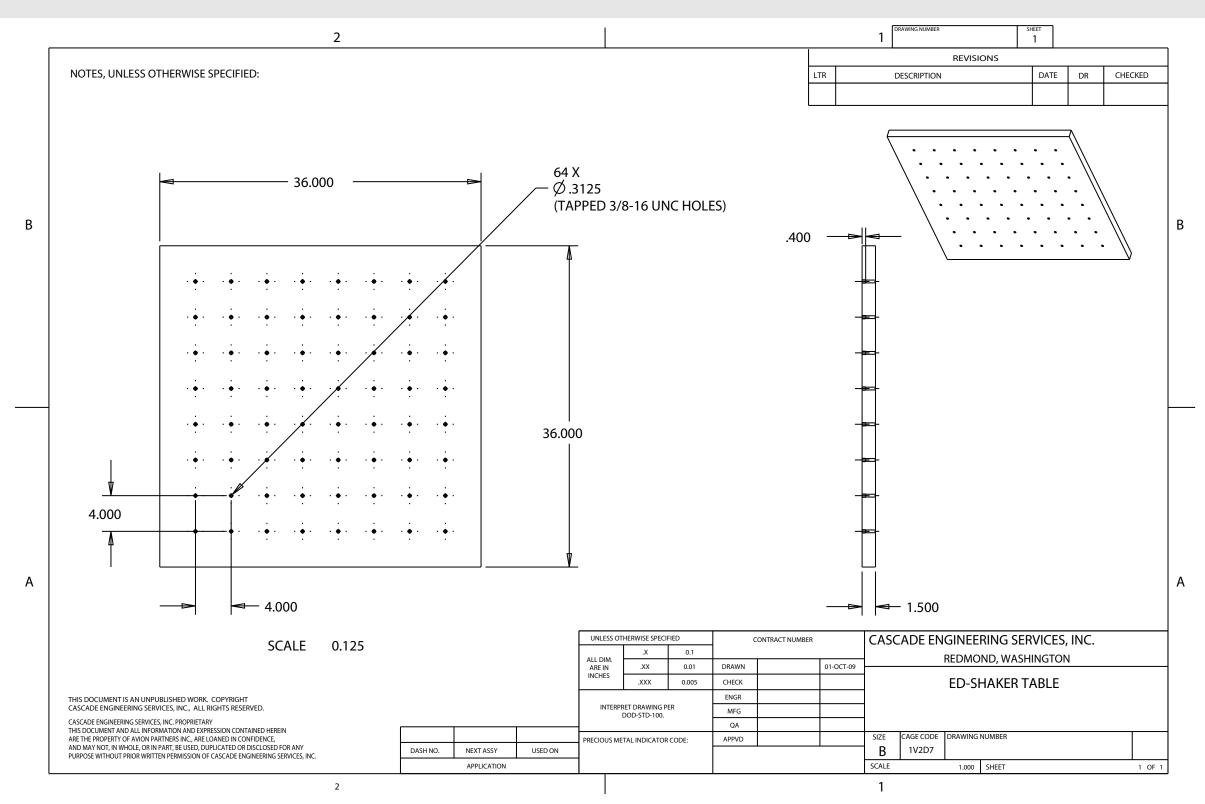
Big Head Expander (Z Axis Orientation)

Small Head Expander (Z Axis Orientation)



Electro-Dynamic Shaker

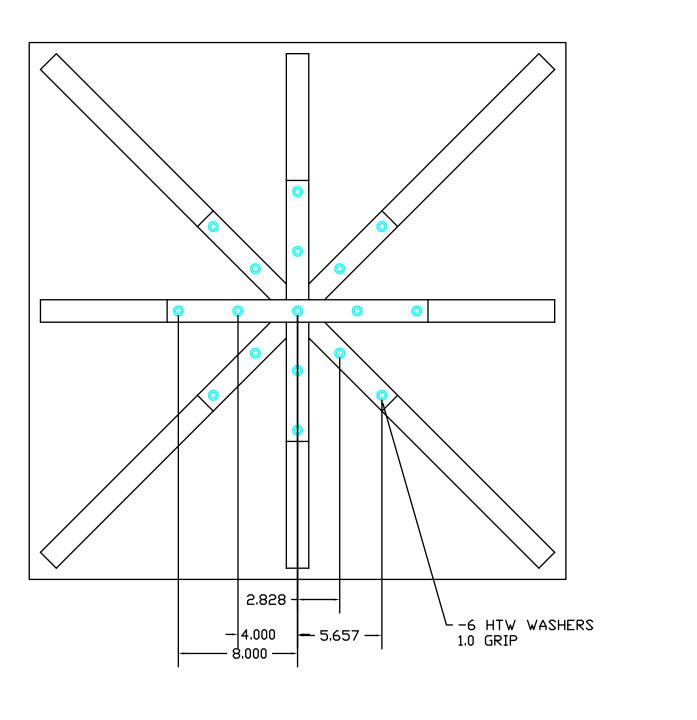
Table Hole Pattern (X & Y Axis Orientation)

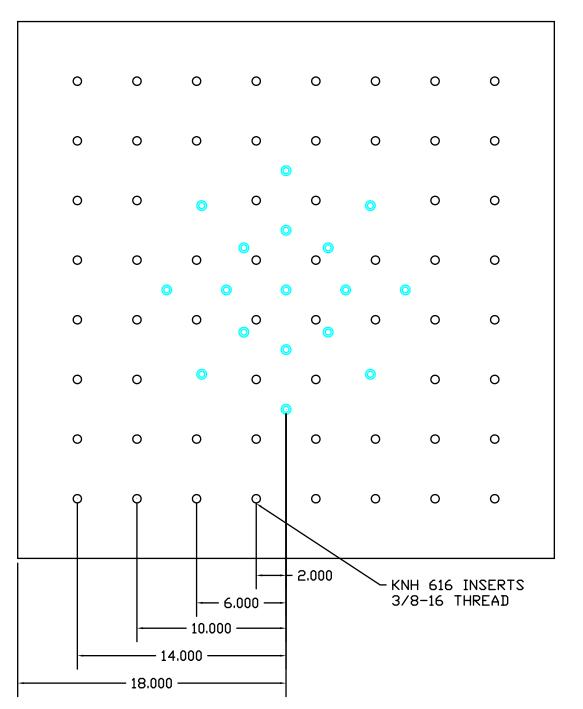




Electro-Dynamic Shaker

Big Head Expander (Z Axis Orientation)

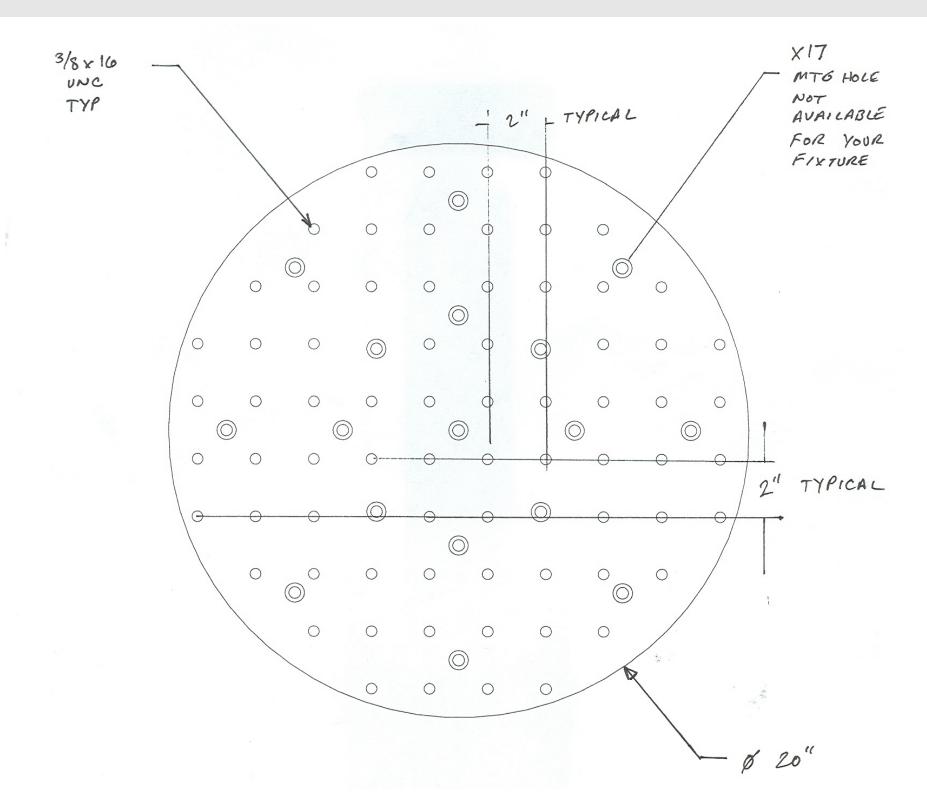






Electro-Dynamic Shaker

Small Head Expander (Z Axis Orientation)





HALT (HASS) Chambers



High Vibration Stresses: Six axis (3 linear & 3 rotational)



Application

Provides simultaneous Temperature - Vibration loads for Accelerated testing, Highly Accelerated Life Testing (HALT) and Highly Accelerated Stress Screening (HASS). This testing is useful for product margin testing. The Chamber is Liquid Nitrogen equipped for rapid temperature ramp changes.

HALT Chamber Spec. (Bare Table)

Models:	AST-35-LN2 & TVC-2.3
Manufacturers:	Thermotron & Hanse
Vibration axis:	6 DOF excitation
Frequency Range:	Up to 10 kHz
Temperature Range:	-87 °C to +191 °C
Max Temperature Ramp Rate:	70 °C / min
Maximum Acceleration:	Up to 50 g rms
Workspace Dimensions:	42"W x 42"D x 40"H
Table Size :	30″x 30″
Chamber Temp Monitor Channels:	5 Channels
Chamber Accelerometer DAQ :	3 Channels
Additional Options:	External DAQs available for
	both Temp & acceleration
	monitoring
	-

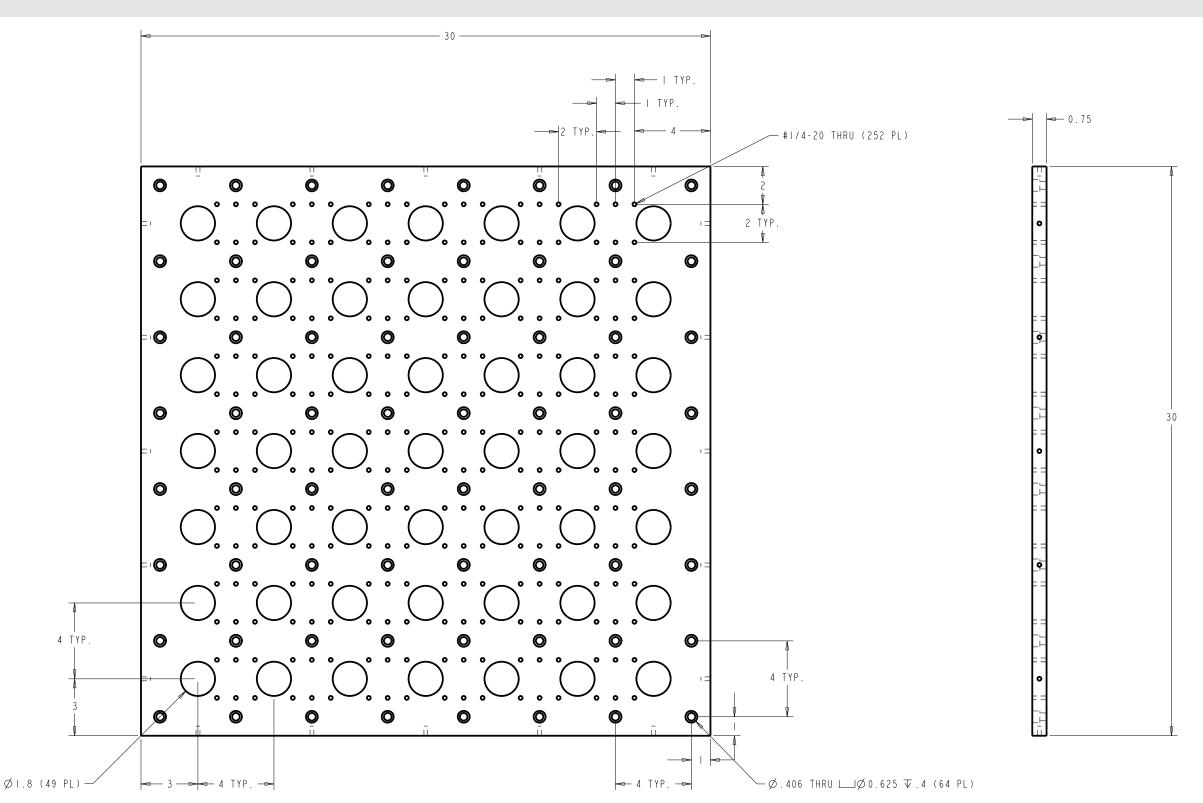
HALT Table Hole Pattern

Table Hole Pattern



HALT (HASS) Chambers

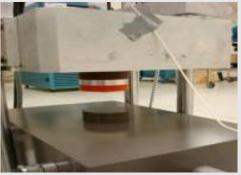
Table Hole Pattern





Mechanical Shock System







Elastomer (open and closed combination)

Gasket and Felt

Application

Performs programmable shock tests / materials impact evaluation for component, PCBA and System level testing.

Mechanical Shock Spec.

Model:	23 with LDS DAQ
Manufacturer:	Lansmont
Drop Height:	3" to 75"
Maximum Acceleration:	5000 g
Maximum Velocity Change :	Up to 36 ft / sec
Maximum Specimen Weight:	80 lbs
Shock Pulse Duration Range:	0.20 msec to 60 msec
Input Wave Type:	Half Sine / Trapezoidal /
	Terminal peak sawtooth

Shock Table Hole Pattern

Table Hole Pattern

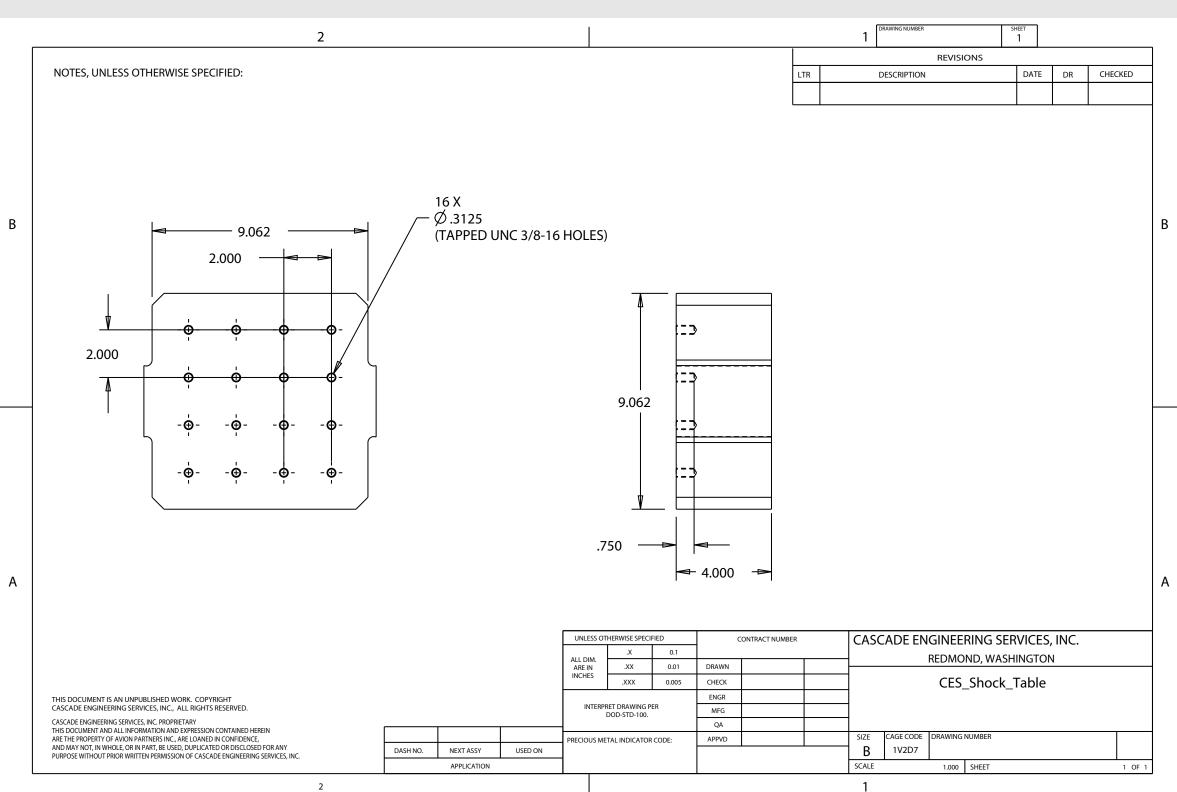


Screw Type Accelerometer to Monitor Table g-level



Mechanical Shock System

Shock Table Hole Pattern



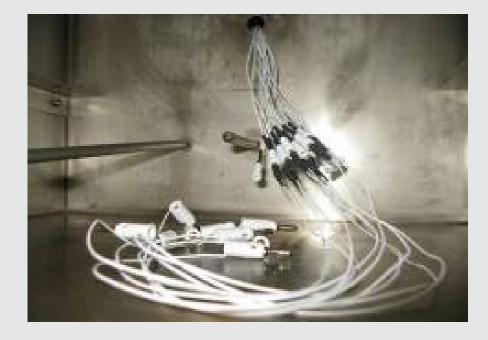


Vacuum Chamber

Application



14 PIN Connectors (Interior /Exterior Chamber)



Altitude and Decompression Chamber that Simulates altitude and rapid decompression for avionic system testing.

Vacuum Chamber Spec.		
Model:	3003	
Manufacturer:	LR Environmental Equipment	
	Company	
Altitude Range:	75,000 ft	
Rapid Decompressions :	8,000 ft to 55,000 ft within	
	15 seconds	
Work Space Dimensions:	18″W x 23.5″D x 18" H	
Electrical Interface:	14 PIN Bulkhead Connectors	





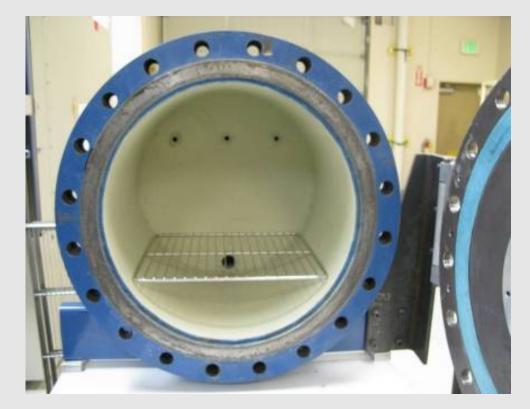
Over-Pressure Chamber

Application

Simulates over-pressure conditions.

Over-Pressure Chamber Spec.

Model:	100
Manufacturer:	Industrial Resources, Inc.
Pressure Range:	95 psi
Work Space Dimensions:	23" Diameter x 20" Depth







Rain and Spray Tester Apparatus

Application

Drip Plate



Spray Nozzle

<u>Drip Plate</u>: This system is used for drip / rain tests. <u>Spray Nozzle</u>: Water Ingression can be simulated by using this apparatus.

Drip Plate Spec.

Manufacturer:	Cascade Engineering Services, Inc.
Volume of Water:	> 30 mL / min
Drip hole diameter:	0.33 mm on a
	25 mm pattern
Work Space Dimensions:	33.5" x 21.5"

Spray Nozzle Spec.		
Manufacturer:	Cascade Engineering Services, Inc.	
Nozzle Diameter:	6.3 mm	
Nozzle Diameter:	12.0 mm	
Flow Meter Spec.		
Manufacturer:	INSITE	
Manufacturer: Water Flow Rate:	INSITE Up to 5 GPM	

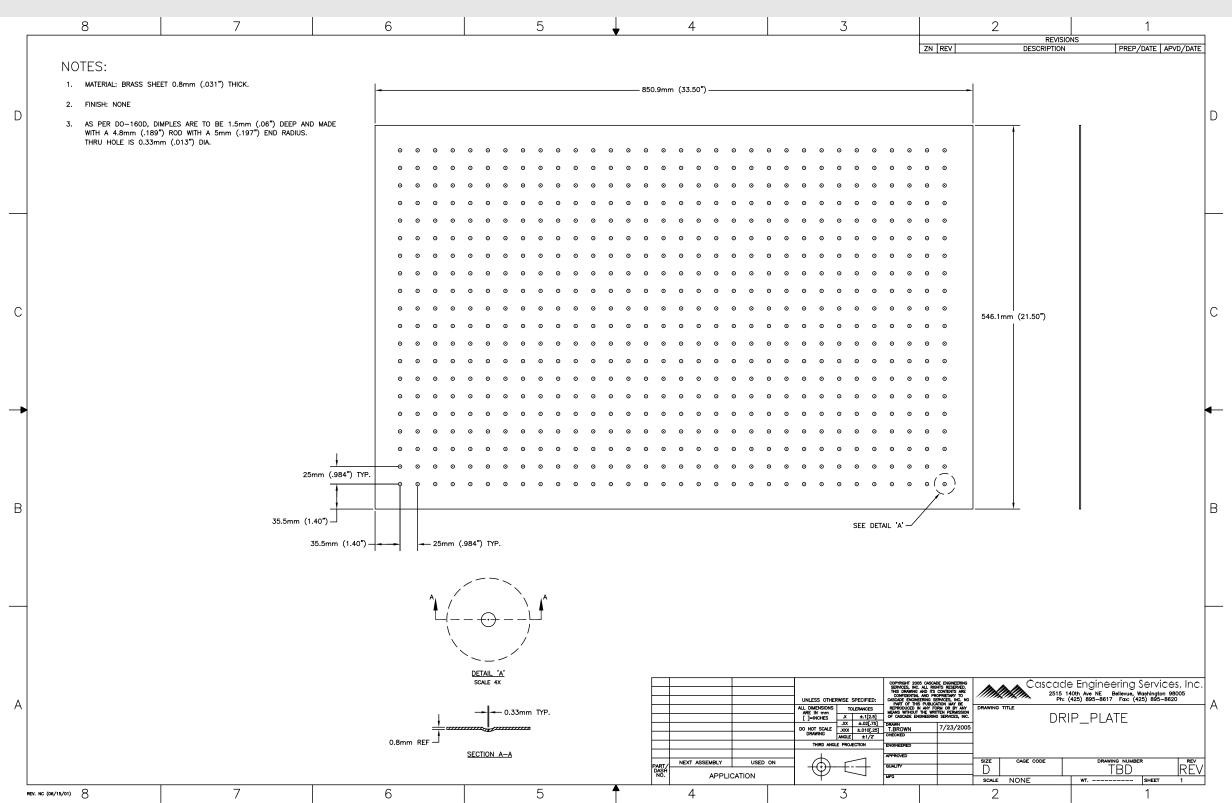
Drip Plate Table Hole Pattern

Table Hole Pattern



Rain and Spray Tester Apparatus

Drip Plate Table Hole Pattern





Salt Fog Chamber

Application

Accelerated corrosion atmospheres can be simulated in this chamber.

Salt Fog Chamber Spec.

Model:	SCCH21
Manufacturer:	Singleton Corporation
Volume:	18 ft ³
Temperature Range:	32 °F to 140 °F
Work Space Dimensions:	36" x 24" x 36"







Settling Dust Chamber

Application

This system can be used to simulate settling dust testing.

Dust Chamber Spec.

Model:	T-27-D
Volume:	27 ft ³
Dust Quantity:	3 kg to 5 kg
Workspace Dimensions:	35.75" x 35.75" x 35.75"







Temperature-Humidity Chambers



Performs Temp-Humidity soaks, Temp Cycling & Low Temp -Humidity tests.

Temp-Humidity Chambers Spec.

Manufacturers:	CSZ / Thermotron / Espec
# of Chambers Available:	>10
Temperature Range :	-70 °C to 190 °C
Temperature Ramp Rate:	3 to 4 °C/ min & 10 to 15 °C/ min
Humidity Range:	5 % to 98 %
Workspace Dimensions:	20"x20"x20" to 48"x56"x48"
Live Load Wattage Rating:	Up to 2500 Watts @ -40 ^o C
	Up to 2100 Watts @ -54 ^o C
	Up to 1000 Watts @ -68 ^o C
Additional Options:	LN2 usage for higher ramp rates
	Product Temperature Control
	Low Temp Humidity Control



Thermal Shock Chamber

THERMOTRO

Application

Used for rapid temperature change loading conditions and thermal shock tests. Transfers the Product Under Test from a cold environment to a hot environment in less than 20 seconds.

Thermal Shock Chamber Spec.

Model:	ATSS-130-6-6
Manufacturer:	Thermotron
Temperature Range :	-73 °C to 215 °C
Temperature Ramp Rate:	12 ℃ / min
Workspace Dimensions:	25" x 23" x 14.5"
Max Specimen weight:	85 lbs
Additional Options:	Product Temperature Control



Tumble Tester

Application

Simulates a normal customer use case with repetitive freefalls.

Tumble Tester Spec.			
Model:	TB-1010		
Manufacturer:	SAFQ		
Drop Height:	500 mm / 100 0mm		
Speed :	5 ± 0.5 rpm (10 falls / min)		
Test Surface:	Steel or Wood		





Walk-in Chamber

Application



This chamber supports either batch processing (high volume projects) or large test systems.

Walk-in Temperature - Humidity Chamber

Model:	EWSX499-30CA
Manufacturer:	Espec
Temperature Range :	-65 °C to 150 °C
Temperature Ramp Rate:	4 °C / min
Humidity Range:	10% to 95%
Workspace Dimensions:	85″x 108″ x 94″, 499 ft3
Live Load Wattage Rating:	4,000 to 30,000 W @ -40 °C to 150 °C





Data Acquisition System (Measurement)

Application

Data Acquisition System (Measurement): Signal-analysis devices used to Measure/Monitor/Record g-levels or accelerations, strains, temperature, voltage, current & resistance changes of the unit under test.

Data Acquisition Systems			
Accelerometer	LDS Dactron FOCUS II : 8-Channel Photon II : 4-Channel Max Sampling Rate : 96kS/sec		
Accelerometer	Data Physics : 4-Channel Max Sampling Rate : 204.8kHz		
Accelerometer (Shock Analysis)	Lansmont Test Partner 4-Channel Max Sampling Rate : 1MHz		
Strain Gage	Vishay Strain Smart 6100 16-Channel DAQ Max Sampling Rate:10,000scans/sec		
Temperature / Voltage Resistance / Current	Agilent 34970A Data Logger 240-Channels Max Sampling Rate:60ch/sec		



Instron Mechanical Test System

Instron: Helpful in Material characterization (Stress/strain curves, Tensile/Flexure strengths, strain measurements etc..) & Product design limit evaluation.

Walk-in Chamber #1 Spec.		
Model:	5569	
Manufacturer:	Instron	
Load Capacity:	Upto 50kN	
Speed:	0.001-500mm/min	
Data Capture Rate:	500Hz	
Test Capabilities:	Tensile	
	Compression	
	Peel	
	3-pt & 4-pt Bend	
Temperature Control:	-70 °C to 350°C	
Accessories:	Extensometer/Deflectometer	



Fatigue Life Testers



MODEL : Linear Abraser 5750



Pnuematic Operated Life Testers

Application

Simulates abrasion & fatigue life testing.

TMA Q400 Spec.			
	Model:	DMA Q800	
	Manufacturer:	Taber Industries	
	Load Capacity :	3 N to 20 N	
	Operating Stroke Length :	0.5 " to 4 "	
	Operating Speed:	2,15,25,30,40,60 cycles/min	
	Abradants / Wearerasers :	Wide selection available	
		(CS 10 ,H18 , wearerasers)	

Fatigue Life Testers

Custom-made Fixtures Max Pressure : 110psi Programmable Test counter Pneumatic cylinders of varying stroke lengths / diameters Flow-control valves for actuation speed control



Dynamic & Thermal Mechanical Analyzer





<u>DMA</u> : Characterization of visco-elastic material properties as a function of time/temperature/frequency

Application

 $\underline{\mathsf{TMA}}$: Material property characterization : CTE, Glass-transition temperature

DMA Q800 Spec.			
Model:	DMA Q800		
Manufacturer:	TA Instruments		
Load Capacity :	18N		
Frequency Range :	0.01 to 200Hz		
Test Fixture Capabilities:	Tensile / Single & Dual Cantilever / Shear		
Operation Modes :	Multi-Frequency / Multi-Strain Creep / Relax		
	Isostrain		
	Stress-Strain Controlled		
Temperature Control:	-145 °C to 600°C with GCS		
TMA Q400 Spec.			
Model:	TMA Q400		
Manufacturer:	TA Instruments		
Load Capacity :	2N		
Test Fixture Capabilities:	Expansion Probe		
Test Fixture Capabilities:	Expansion Probe Macro Expansion Probe		
Test Fixture Capabilities:	•		
Test Fixture Capabilities: Temperature Control:	Macro Expansion Probe		



Adhesive Pull & Peel System

Application



Designed to measure the force required to peel/pull a sample from its backing material or substrate.

Adhesive Pull & Peel System Spec.			
Model:	2820-036		
Manufacturer:	Instron		
Maximum Load:	1kN		
Maximum Peel Length	250mm		
Available Test Angles	30 [°] , 45 [°] , 60 [°] , 90 [°] , 120 [°] , 135 [°] , 150 [°]		



Instron Universal Mechanical Test Machine



50KN Frame Capability with Chamber

Applications

Adhesives, Consumer Electronics, Automotive, Composites, Medical devices, Plastic and Rubber Products

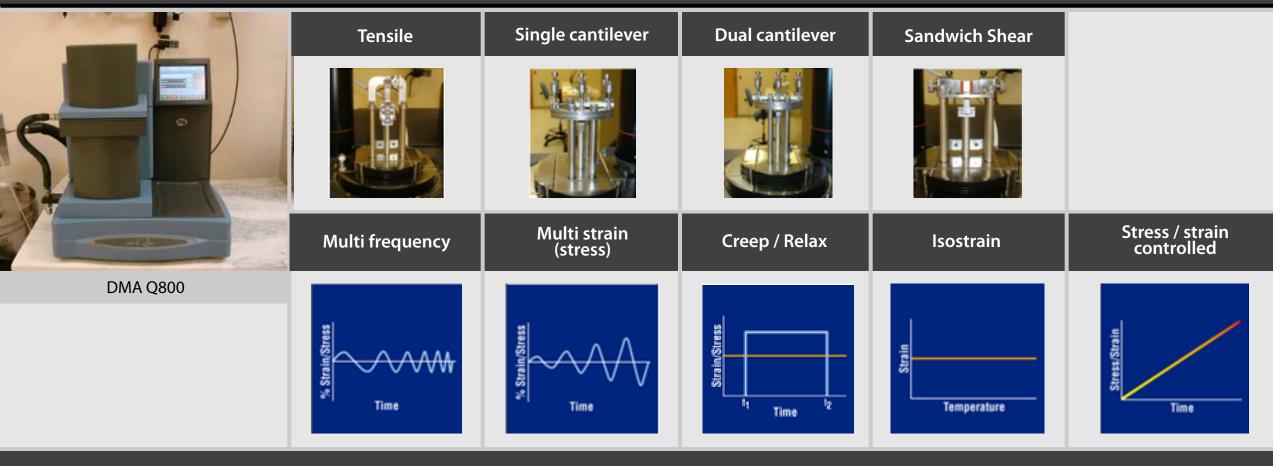
- Stress-Strain including yield, strength determination
- Evaluating effect of temperature on material properties

Test Type	Fixture / Accessories	With Chamber	Capabilities
Tensile			Maximum specimen thickness between jaw faces: 20mm (1.18in) Maximum Load: 10KN Maximum Torque: 80Nm Temperature Rating: -70°C to 125°C Weight: Upper Grip: 4.25Kg (9.37LB) Lower Grip: 4.65Kg(10.25LB)
Compression			Maximum Load: 10KN Diameter: 150mm (6in) Weight: 3.4Kg (7.5LB) Temperature Rating: -70°C to 125°C
Flexure-3 point bend			Load Capacity: 5KN (1000LB) Temperature Rating: -100°C to 350°C Maximum span (lower anvil): 194mm (7.64in) Maximum travel distance (upper anvil): 50mm (2.36in) Weight: Upper anvil assembly: 2.97N (0.67LB) Lower anvil assembly: 32.5N (7.24LB)
Flexure-4 point bend			Load Capacity: 5KN (1000LB) Temperature Rating: -100°C to 350°C Maximum span (lower anvil): 194mm (7.64in) Maximum span (upper anvil): 97mm (3.82in) Maximum travel distance (upper anvil): 50mm (2.36in) Weight: Upper anvil assembly: 1.40Kg (0.67LB) Lower anvil assembly: 3.25Kg (7.24LB)
Variable angle peel			Maximum Load: 1KN (225LBF) Sled width: 150mm (5.9in) Maximum Peel Length: 250mm (9.84in) Maximum Substrated dimensions: Width-130mm (5.1in) Length- 250mm (9.84in) Maximum substrate thickness: 7mm(0.27in)

Available angles: 30°, 45°, 60°, 90°, 120°, 135°, 150°



Dynamic Mechanical Analyzer



Applications

1) Material properties characterization:

- Storage modulus, Loss modulus, tan delta
- Glass transition temperature, deflection temperature under load, softening temperature, melting temperature
- Frequency and temperature effects on storage modulus, loss modulus, tan delta
- Frequency effect on glass transition temperature
- 2) Predicting material performance using time/temperature superposition (TTS, time-temperature superposition)
- 3) Evaluating process effects on material properties
- 4) Comparing different material candidates or different suppliers
- 5) Evaluating Shock absorption characteristics of elastomers, gaskets



Thermo Mechanical Analyzer



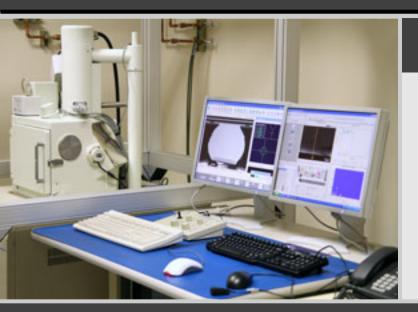
Deformation mode	Expansion Probe	Macro Expansion Probe	Penetration Probe
 Expansion Probe Macro Expansion Probe Penetration Probe 			

TMA Q400

- 1) Material properties characterization:
 - CTE, Tg, Softening Temperature
 - Inputs for FA, Design Analysis (FEA) or RCA
- 2) Evaluating Process effects on material properties and reliability
- 3) Comparing different material candidates or different suppliers



Scanning Electron Microscope



Features

- Resolution
 - High Vacuum mode: 3.0nm (30kV)
 - Low Vacuum mode: 4.0nm (30kV)
- Acceleration Voltage: 0.3 to 30kV
- Magnification: 5 to 300,000
- EMI cage for AC noise reduction
- Low vacuum mode for studying non-conductive samples
- Energy Dispersive Spectrum for Elemental Analysis (Qualitative and Quantitative)
- Elemental Mapping

- Surface morphology imaging for all types of sample including metals, ceramics, polymers, etc...
- Conductive and non-conductive samples
- Together with cross section grinding/polishing equipments, SEM is a perfect tool to detect defects such voids, cracks, delaminations, in IC components such as solder joints in PCBs.
- Elemental analysis and elemental mapping using energy dispersive spectrum technique (EDS) in all types of sample
- Effective measurement tool for thin films, intermetallic layers, Solder joint geometry etc

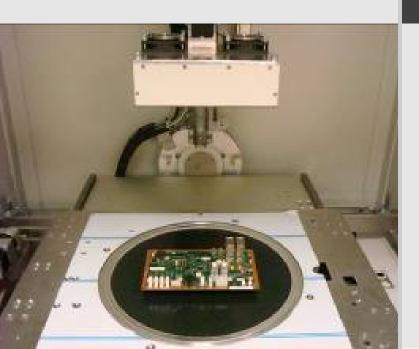


X-Ray: 2D and 3D Capabilities



Features

- Multi-focus tube with High Power, Nanofocus and Microfocus Capabilities; Open tube, enabling smaller spot size and higher spatial resolution down to 0.5 um.
- High power transmission target
- 10-160 kV
- 5-Motor driven axes
- 140+ degree oblique viewing via detector tilt
- 360 degree rotational sample table
- 2D and 3D-CT imaging
- Flat panel HD detector, 10~30 frames per second
- BGA analysis, Void calculations, Die attach analysis
- CNC capability



- Non-destructive Failure analysis tool
- Inspection of IC components & solder joints on printed circuit boards
 - Typical defects: Cracks, Opens, Bridging, Voiding, Misalignment, Missing joints etc
- Inspection of active and passive components, electronic components and hybrid modules
- Checking electromechanical components, especially those that are fully enclosed, such as sensors, relays, safety fuses, coils etc.
- · Inspection of plastics, ceramics, light metals and steel
- Evaluating Process effects on product reliability
- Root cause analysis of product failures from Usage or Test conditions



Cross-Sectioning Capabilities

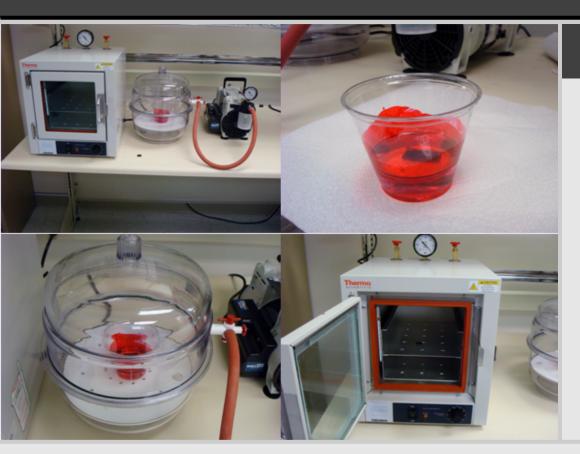


Features

- 3 Grinders/Polishers for seamless and high volume needs
- Diamond and Band saw for precision cut
- Epoxy Dispenser for grinding/polishing
- Metallographic and Hi-Mag Microscopy tools with Digital photography



Dye and Pry Capabilities



Applications

Destructive failure analysis technique for delamination, voids or cracks in area array solder joints or other IC circuits in PCBs.



Optical Microscope with Stitching Capability



Features

- Up to 1000x
- DIC, Darkfield/Brightfield and multiple light filtering capabilities
- Olympus UC50 Camera with 4-24 fps & 5MegaPixel
- Motorized Z stage for EFI and Stacked Imaging
- Software features: Automated Z Stack Acquisition and Stitching Capability enables better resolution/focus for failed parts and assemblies

- Non-destructive Failure analysis tool
- Inspection of IC components & solder joints on printed circuit boards
 - Typical defects: Cracks, Opens, Bridging, Voiding, Misalignment, Missing joints etc
- Inspection of active and passive components, electronic components and hybrid modules
- Stacked Imaging and Stitching-good potential for composite imaging of cracked, failed, fractured surfaces